

Title (en)

AN IMPROVED LASER ABLATEABLE MATERIAL

Title (de)

EIN VERBESSERTER LASERABSCHIEDBARES MATERIAL

Title (fr)

MATERIAU AMELIORE POUVANT SUBIR UNE ABLATION PAR UN RAYONNEMENT LASER

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Application

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Priority

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Abstract (en)

[origin: WO9627212A1] This invention discloses a method for coating an integrated circuit (3) with a layer of plasma deposited polymers (PDP) ablateable by visible light laser radiation.

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H01L 29/00

IPC 8 full level

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Citation (search report)

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